

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

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LI1812D121R-10

UNCONTROLLED DOCUMENT

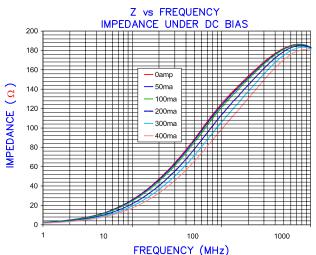
PHYSICAL DIMENSIONS:

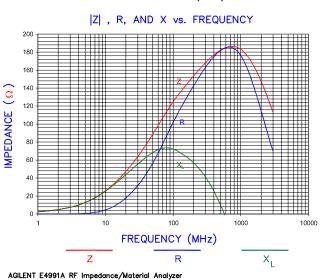
A 4.50 [.177] \pm 0.25 [.010]

B 3.20 [.126] ± 0.25 [.010]

C 1.40 [.055] ± 0.25 [.010]

D 0.46 [.018] \pm 0.20 [.008]

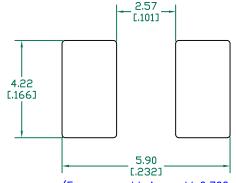




HP 16194A Test Fixture. TEST REF. 3337

P6)

LAND PATTERNS FOR REFLOW SOLDERING



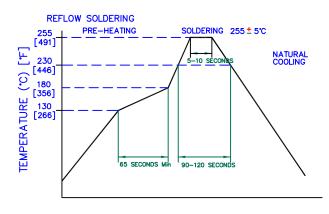
(For wave soldering, add 0.762 (.030) to this dimension)

ELECTRICAL CHARACTERISTICS:										
Z @ 100M (<u>Ω</u>)	1Hz	DCR (Ω)	Rated Current							
Nominal	120									
Minimum	90									
Maximum	150	0.400	400 mA							

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 13" REELS, 2500 PCS/REEL.
- 2. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 3. TERMINATION FINISH IS 100% TIN.
- 4. OPERATING TEMP. RANGE: -40°C~+125°C. (INCLUDING SELF-HEATING)

RECOMMENDED SOLDERING CONDITIONS





DIMENSIONS ARE IN mm [INCHES].				This print is the property of Laird					
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				copies shall be made without the			u		
				written consent of Laird Tech. Al rights to design or invention are		_			
				reserved.					
				PROJECT/PART NUMBER:	T	ÆV	PART TO	PE:	DRAWN BY:
С	ADD OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13	QU	LI1812D121R-10		С	CO-	-FIRE	JRK
В	UPDATE COMPANY LOGO ADD ROHS SYM	07/24/08	JRK	DATE: OR /1.C /O.4	CAL	E:	TC	SHEET:	
Α	ORIGINAL DRAFT	08/16/04	JRK	O8/16/04	OOL		TS	_	
REV	DESCRIPTION	DATE	INT		OUL	• -	-	2	of 3